Memory FRAM

CMOS

256 K (32 K × 8) Bit SPI

MB85RS256

■ DESCRIPTION

MB85RS256 is a FRAM (Ferroelectric Random Access Memory) chip in a configuration of 32,768 words \times 8 bits, using the ferroelectric process and silicon gate CMOS process technologies for forming the nonvolatile memory cells.

MB85RS256 adopts the Serial Peripheral Interface (SPI).

The MB85RS256 is able to retain data without using a back-up battery, as is needed for SRAM.

The memory cells used in the MB85RS256 can be used for 10¹⁰ read/write operations, which is a significant improvement over the number of read and write operations supported by Flash memory and E²PROM.

MB85RS256 does not take long time to write data unlike Flash memories nor F²PROM, and MB85RS256 takes

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■ FEATURES

• Bit configuration : 32,768 words × 8 bits

Operating power supply voltage
 Operating frequency
 3.0 V to 3.6 V
 15 MHz (Max)

• Serial Peripheral Interface : SPI (Serial Peripheral Interface)

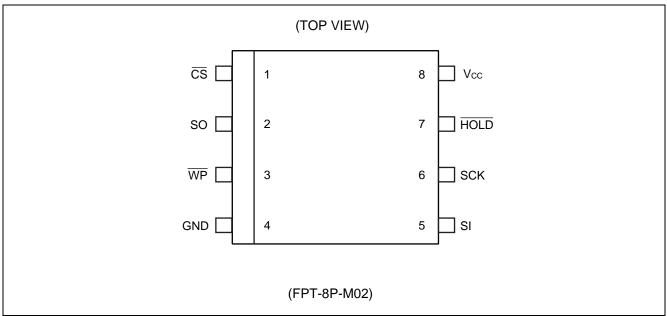
Correspondent to SPI mode 0 (0, 0) and mode 3 (1, 1)

Operating temperature range
 Data retention
 High endurance
 -20 °C to +85 °C
 10 years (+55 °C)
 10 Billion Read/writes

Package : 8-pin plastic SOP (FPT-8P-M02)



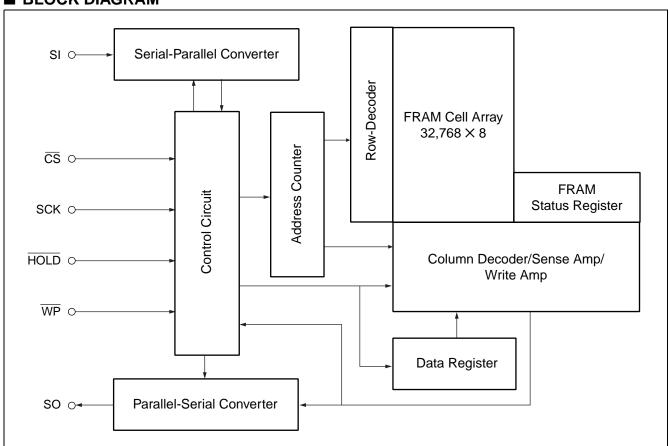
■ PIN ASSIGNMENT



■ PIN FUNCTIONAL DESCRIPTIONS

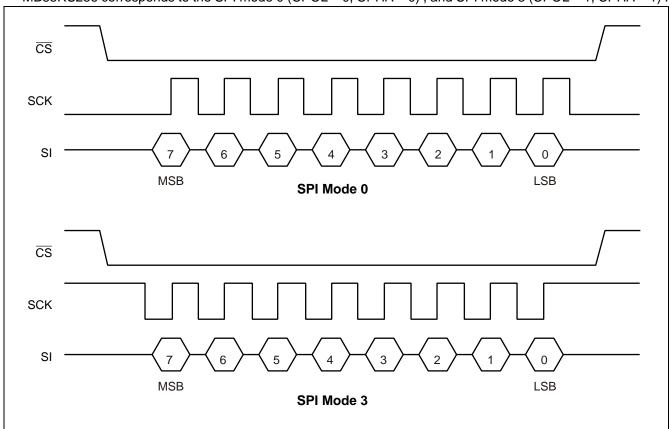
Pin No.	Pin Name	Functional description
1	CS	Chip Select This is an input pin to make chips select. When \overline{CS} is "H", device is in deselect (standby) status as long as device is not write status internally, and SO becomes High-Z. Other inputs from pins are ignored for this time. When \overline{CS} is "L", device is in select (active) status. \overline{CS} has to be "L" before inputting op-code.
3	WP	Write Protect This is a pin to control writing to a status register. When WP is "L", writing to a status register is not operated.
7	HOLD	Hold This pin is used to interrupt serial input/output without making chips deselect. When HOLD is "L", hold operation is activated, SO becomes High-Z, SCK and SI become don't care. While the hold operation, CS has to be retained "L".
6	SCK	Serial Clock This is a clock input pin to input/output serial data. SI is loaded synchronously to a rising edge, SO is output synchronously to a falling edge.
5	SI	Serial Data Input This is an input pin of serial data. This inputs op-code, address, and writing data.
2	SO	Serial Data Output This is an output pin of serial data. Reading data of FRAM memory cell array and status register data are output. This is High-Z during standby.
8	Vcc	Supply Voltage
4	GND	Ground

■ BLOCK DIAGRAM



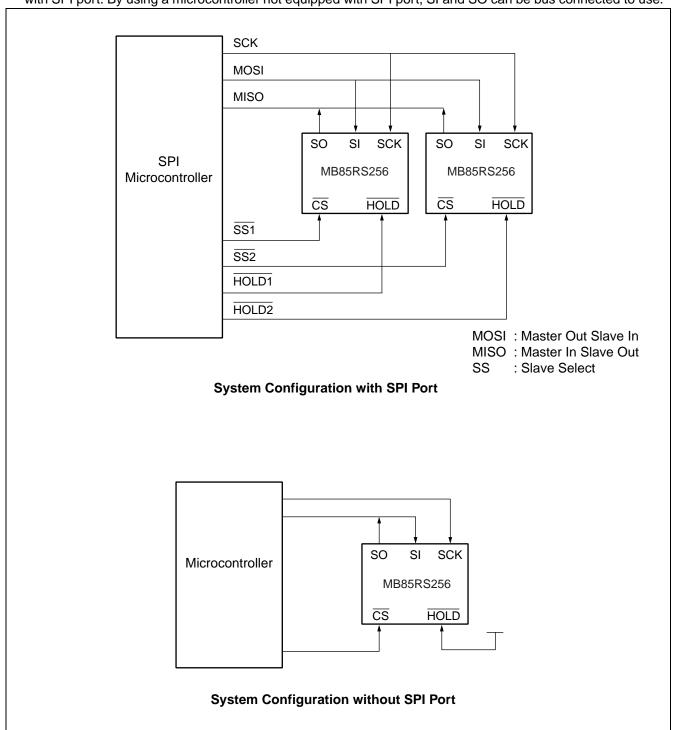
■ SPI MODE

MB85RS256 corresponds to the SPI mode 0 (CPOL = 0, CPHA = 0), and SPI mode 3 (CPOL = 1, CPHA = 1).



■ SERIAL PERIPHERAL INTERFACE (SPI)

MB85RS256 works as a slave of SPI. More than 2 devices can be connected by using microcontroller equipped with SPI port. By using a microcontroller not equipped with SPI port, SI and SO can be bus connected to use.



■ STATUS REGISTER

Bit No.	Bit Name	Function
7	WPEN	Status Register Write Protect This is a bit composed of nonvolatile memories (FRAM). WPEN is related to WP input to protect writing to a status register (refer to "■ WRITING PROTECT"). Writing with the WRSR command and reading with the RDSR command are possible.
6 to 4	_	Not Used Bits These are bits composed of nonvolatile memories, writing with the WRSR command is possible, and "000" is written before shipment. These bits are not used but they are read with the RDSR command.
3	BP1	Block Protect This is a bit composed of nonvolatile memory (FRAM). This defines block
2	BP0	size for writing protect with the WRITE command (refer to "■ BLOCK PROTECT"). Writing with the WRSR command and reading with the RDSR command are possible.
1	WEL	Write Enable Latch This indicates FRAM memory and status register are writable. The WREN command is for setting, and the WRDI command is for resetting. With the RDSR command, reading is possible but writing is not possible with the WRSR command. WEL is reset after the following operations. The time when power is up. The time when the WRDI command is input. The time when the WRSR command is input. The time when the WRITE command is input.
0	0	This is a bit fixed to "0".

■ OP-CODE

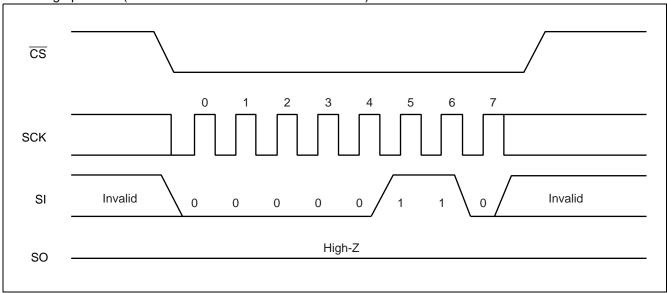
MB85RS256 accepts 6 kinds of command specified in op-code. Op-code is a code composed of 8 bits shown in the table below. When invalid codes other than codes below are input, they are ignored. If $\overline{\text{CS}}$ is risen while inputting op-code, the command are not performed.

Name	Description	Op-code
WREN	Set Write Enable Latch	0000 0110в
WRDI	Reset Write Enable Latch	0000 0100в
RDSR	Read Status Register	0000 0101в
WRSR	Write Status Register	0000 0001в
READ	Read Memory Code	0000 0011в
WRITE	Write Memory Code	0000 0010в

■ COMMAND

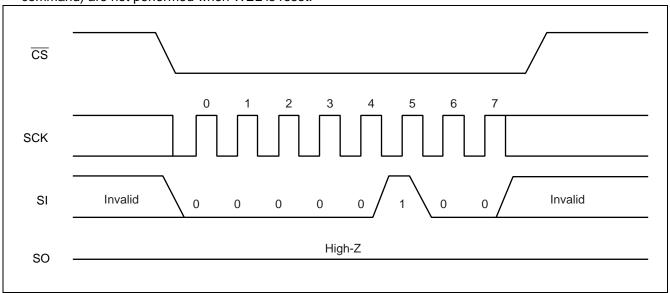
• WREN

The WREN command sets WEL (Write Enable Latch) . WEL has to be set with the WREN command before writing operation (WRSR command and WRITE command) .



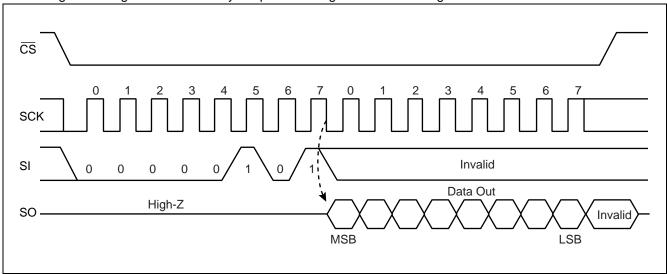
• WRDI

The WRDI command resets WEL (Write Enable Latch) . Writing operation (WRITE command and WRSR command) are not performed when WEL is reset.



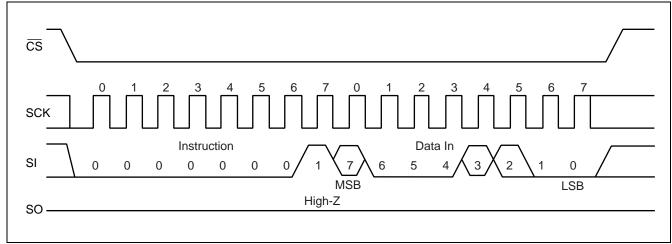
• RDSR

The RDSR command reads status register data. After op-code of RDSR is input to SI, 8-cycle clock is input to SCK. The SI value is invalid for this time. SO is output synchronously to a falling edge of SCK. Continuously reading status register is enabled by keep on sending SCK before rising CS with the RDSR command.



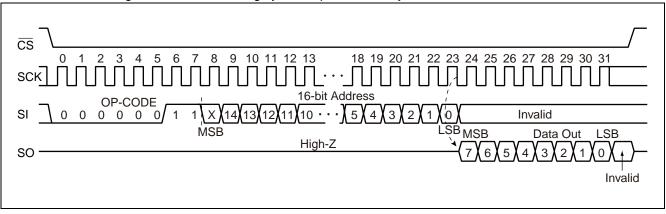
WRSR

The WRSR command writes data to the nonvolatile memory bit of status register. After performing WRSR opcode to a SI pin, 8 bits writing data is input. WEL (Write Enable Latch) is not able to be written with WRSR command. a SI value correspondent to bit 1 is ignored. Bit 0 of the status register is fixed to "0" and cannot be written. The SI value corresponding to bit 0 is ignored.



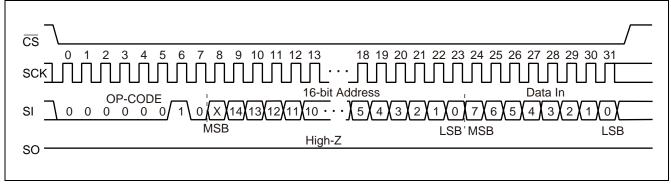
• READ

The READ command reads FRAM memory cell array data. Arbitrary 16 bits address and op-code of READ are input to SI. The most significant address bit is invalid. Then, 8-cycle clock is input to SCK. SO is output synchronously to the falling edge of SCK. While reading, the SI value is invalid. When \overline{CS} is risen, the READ command is completed, but keep on reading address with automatic increment is enabled by continuously sending clock for 8 cycles each to SCK before \overline{CS} is risen. When it reaches the most significant address, it rolls over to come back to the starting address, and reading cycle keeps on infinitely.



WRITE

The WRITE command writes data to FRAM memory cell array. WRITE op-code, arbitrary 16 bits of address and 8 bits of writing data are input to SI. The most significant address bit is invalid. When 8 bits of writing data is input, data is written to FRAM memory cell array. Risen \overline{CS} will terminate the WRITE command, but if you continue sending the writing data for 8 bits each before \overline{CS} is risen, it is possible to continue writing with automatic address increment. When it reaches the most significant address, it rolls over, comes back to the starting address, and writing cycle can be continued infinitely.



■ BLOCK PROTECT

Writing protect block is configured by the WRITE command with BP1, BP0 value of the status register.

BP1	BP0	Protected Block
0	0	None
0	1	6000н to 7FFFн (upper 1/4)
1	0	4000н to 7FFFн (upper 1/2)
1	1	0000н to 7FFFн (all)

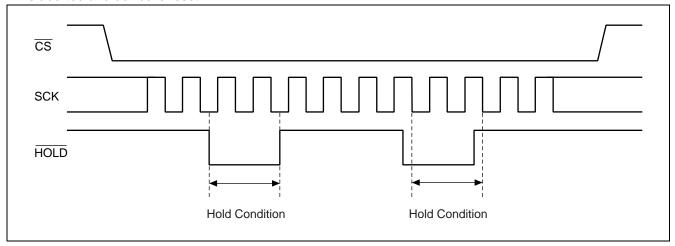
■ WRITING PROTECT

Writing operation of the WRITE command and the WRSR command are protected with the value of WEL, WPEN, WP as shown in the table.

WEL	WPEN	WP	Protected Blocks	Unprotected Blocks	Status Register
0	Х	Х	Protected	Protected	Protected
1	0	Х	Protected	Unprotected	Unprotected
1	1	0	Protected	Unprotected	Protected
1	1	1	Protected	Unprotected	Unprotected

■ HOLD OPERATION

Hold status is retained without aborting a command if \overline{HOLD} is "L" while \overline{CS} is "L". The timing for starting and ending hold status depends on the SCK to be "H" or "L" when a \overline{HOLD} pin input is transited as shown in the diagram below. Arbitrary command operation is interrupted in hold status, SCK and SI inputs become don't care. And, SO becomes High-Z while reading command (RDSR, READ) . If \overline{CS} is risen with hold status, a command is aborted and device is reset.



■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ra	Unit		
rarameter	Symbol	Min	Max	Onit	
Power supply voltage	Vcc	- 0.5	+ 4.0	V	
Input voltage	Vin	- 0.5	Vcc + 0.5	V	
Output voltage	Vouт	- 0.5	Vcc + 0.5	V	
Operating temperature	TA	- 20	+ 85	°C	
Storage temperature	Tstg	- 40	+ 125	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol		Value		Unit	
Farameter	Syllibol	Min	Тур	Max	Offic	
Power supply voltage	Vcc	3.0	3.3	3.6	V	
Input high voltage	VIH	Vcc × 0.8	_	Vcc + 0.5	V	
Input low voltage	VıL	- 0.5	_	+ 0.6	V	
Operating temperature	TA	- 20	_	+ 85	°C	

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

(within recommended operating conditions)

Parameter	Symbol	Condition		Unit		
Farameter	Symbol	Condition	Min	Тур	Max	Ullit
Input leakage current	lu	V _{IN} = 0 V to V _{CC}	_	_	10	μΑ
Output leakage current	ILO	Vout = 0 V to Vcc	_	_	10	μΑ
Operating power supply current	Icc	SCK = 15 MHz		5	10	mA
Standby current	İsb	All inputs Vss or $SCK = SI = \overline{CS} = Vcc$	_	3	50	μА
Output high voltage	Vон	Iон = −2 mA	$Vcc \times 0.8$	_	_	V
Output low voltage	Vol	IoL = 2 mA	_	_	0.4	V

2. AC Characteristics

(within recommended operating conditions)

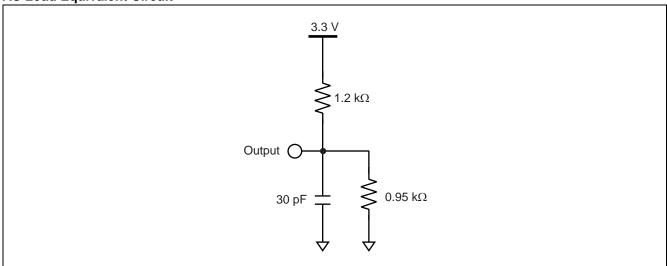
Deremeter	Symbol	Va	lue	Unit
Parameter	Symbol	Min	Max	Unit
SCK clock frequency	fск	0	15	MHz
Clock high time	tсн	30	_	ns
Clock low time	t cL	30	_	ns
Chip select set up time	tcsu	10	_	ns
Chip select hold time	tсsн	10	_	ns
Output disable time	top	_	20	ns
Output data valid time	todv	_	35	ns
Output hold time	tон	0	_	ns
Deselect time	t□	60	_	ns
Data in rise time	tR	_	50	ns
Data fall time	t⊧	_	50	ns
Data set up time	t su	5	_	ns
Data hold time	tн	5	_	ns
HOLD set up time	t Hs	10	_	ns
HOLD hold time	tнн	10	_	ns
HOLD output floating time	tнz	_	20	ns
HOLD output active time	tız		20	ns

AC Test Condition

Power supply voltage : 3.0 V to 3.6 V Operation temperature $: -20 \,^{\circ}\text{C}$ to $+85 \,^{\circ}\text{C}$ Input voltage magnitude : 0.3 V to 2.7 V

Input rising time : 5 ns
Input falling time : 5 ns
Input judge level : Vcc/2
Output judge level : Vcc/2



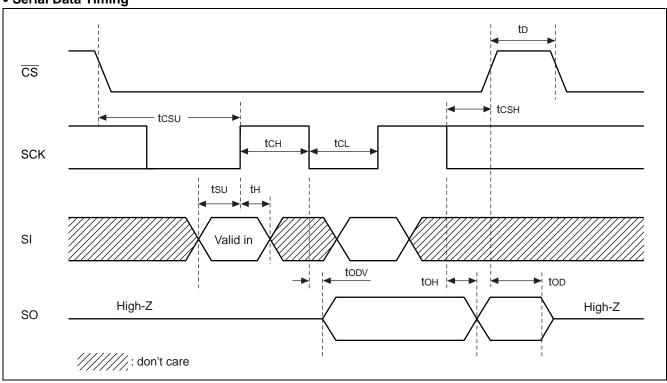


3. Pin Capacitance

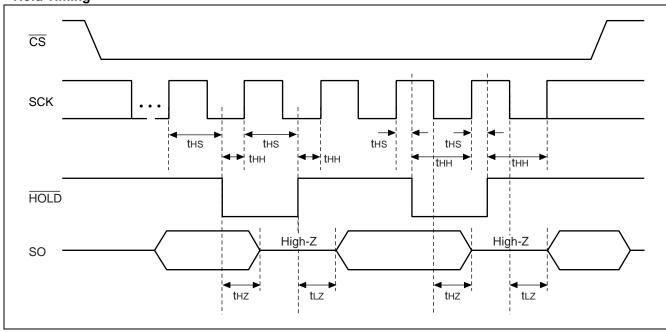
Parameter	Symbol	Va	Unit	
Farameter	Symbol Min		Max	Offic
Output capacitance	Со	_	10	pF
Input capacitance	Cı	_	10	pF

■ TIMING DIAGRAM

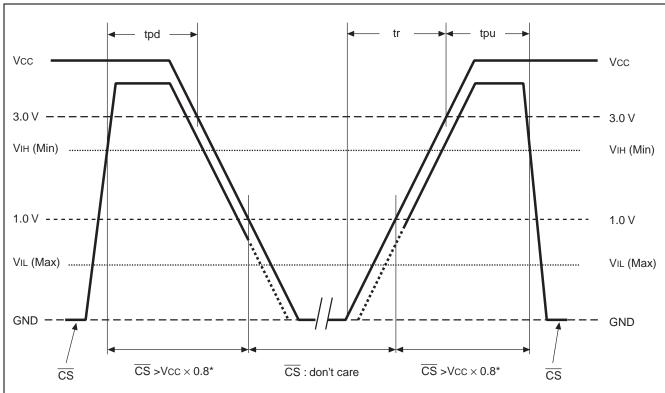
• Serial Data Timing



• Hold Timing



■ POWER ON/OFF SEQUENCE



* : CS (Max) < Vcc + 0.5 V

Note: • Because turning the power-on from an intermediate level may cause malfunctions, when the power is turned on, Vcc is required to be started from 0 V.

• If the device does not operate within the specified conditions of read cycle, write cycle, power on/ off sequence, memory data can not be guaranteed.

Parameter	Symbol	Val	Unit		
Farameter	Syllibol	Min	Max	Jill	
CS level hold time at power OFF	tpd	85	_	ns	
CS level hold time at power ON	tpu	85	_	ns	
Power supply rising time	tr	0.05	200	ms	

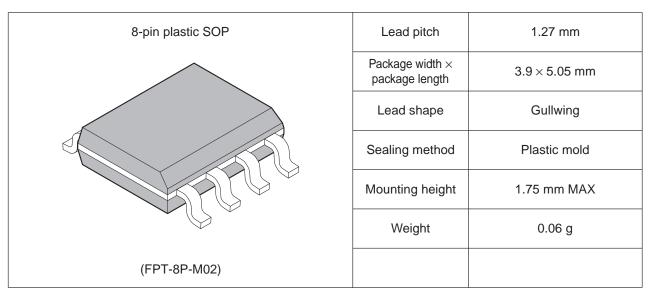
■ NOTES ON USE

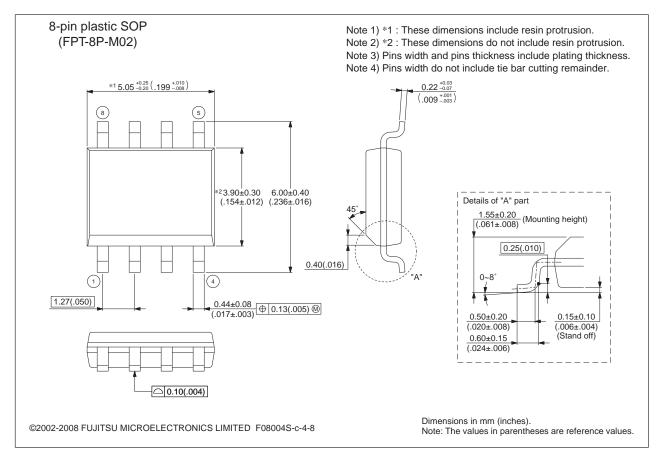
After the IR reflow completed, it is not guaranteed to save the data written prior to the IR reflow.

■ ORDERING INFORMATION

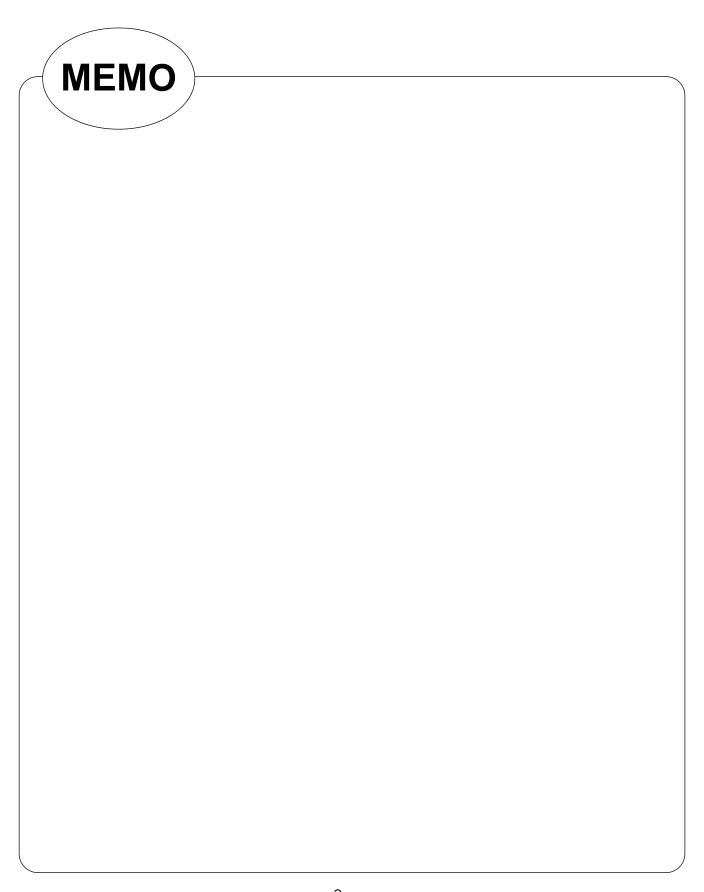
Part number	Package	Remarks
MB85RS256PNF-G-JNE1	8-pin plastic SOP (FPT-8P-M02)	
MB85RS256PNF-G-JN-ERE1	8-pin plastic SOP (FPT-8P-M02)	Embossed Carrier tape

■ PACKAGE DIMENSION





Please confirm the latest Package dimension by following URL. http://edevice.fujitsu.com/package/en-search/



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